

#### 3.0mmx1.0 mm RIGHT ANGLE SMD **CHIP LED LAMP**

Part Number: APA3010ZGC/E-GX Green



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES** 

#### **Features**

- 3.0mmx1.0mm right angle SMT LED, 2.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for back light and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

#### Description

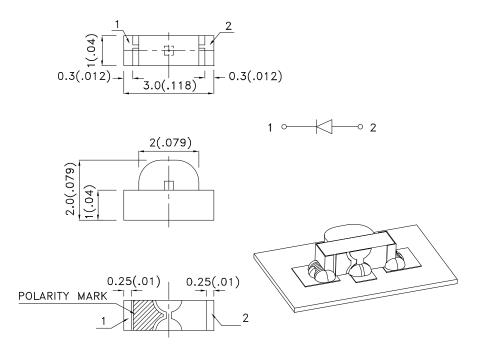
The Green source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4.The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAL5011 **REV NO: V.1 DATE: DEC/24/2010** PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.H.Wu ERP: 1203010248

### **Selection Guide**

Part No.	Dice	Lens Type	@ 20m Å Anglo [	Viewing Angle [1]	
		2.	Min.	Тур.	201/2
APA3010ZGC/E-GX	Green (InGaN)	Water Clear	300	500	120°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
  2. Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	520		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	IF=20mA
С	Capacitance	Green	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	4	V	IF=20mA
lr	Reverse Current	Green		50	uA	V <sub>R</sub> =5V

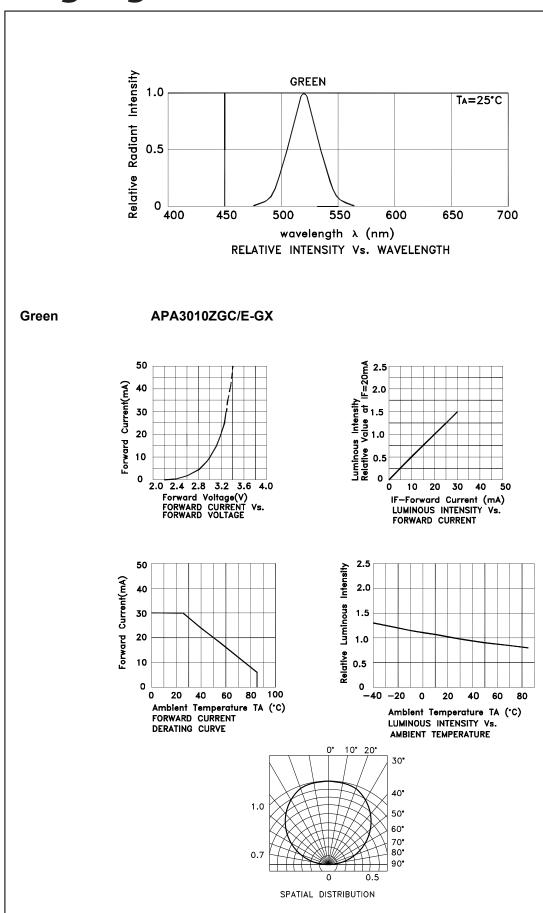
- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Green		
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAL5011 **REV NO: V.1** DATE: DEC/24/2010 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.H.Wu ERP: 1203010248



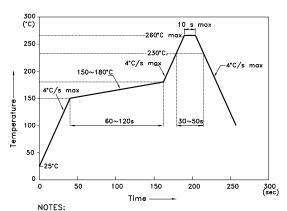
 SPEC NO: DSAL5011
 REV NO: V.1
 DATE: DEC/24/2010
 PAGE: 3 OF 5

 APPROVED: WYNEC
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#### APA3010ZGC/E-GX

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



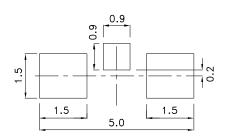
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

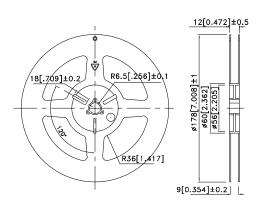
  3.Number of reflow process shall be 2 times or less.

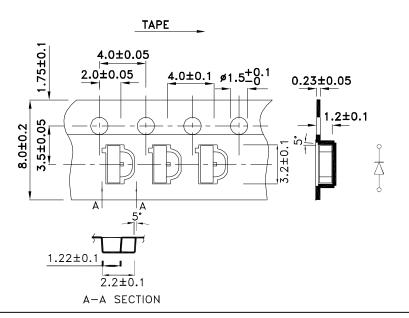
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



### **Tape Dimensions** (Units : mm)

### **Reel Dimension**

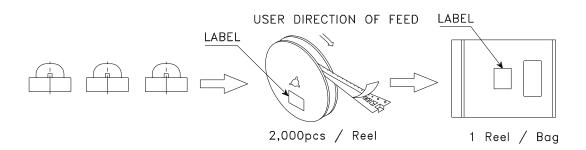


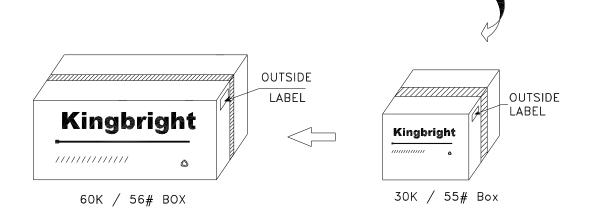


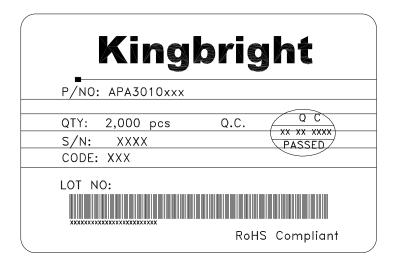
SPEC NO: DSAL5011 **REV NO: V.1 DATE: DEC/24/2010** PAGE: 4 OF 5 CHECKED: Allen Liu APPROVED: WYNEC ERP: 1203010248 DRAWN: Y.H.Wu

## PACKING & LABEL SPECIFICATIONS

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SPEC NO: DSAL5011 APPROVED: WYNEC REV NO: V.1 CHECKED: Allen Liu DATE: DEC/24/2010 DRAWN: Y.H.Wu PAGE: 5 OF 5 ERP: 1203010248